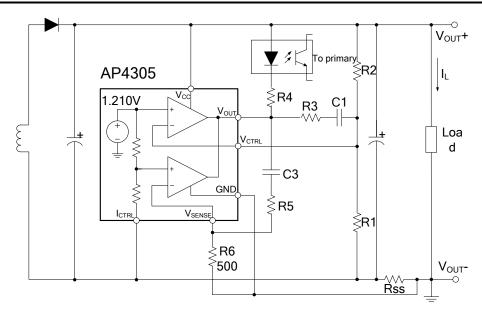


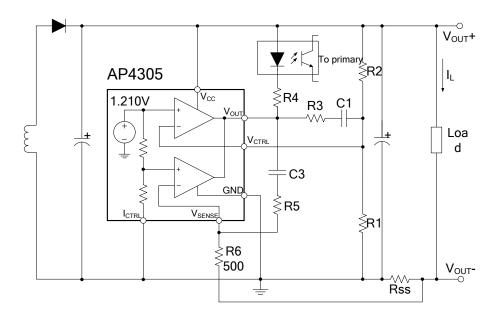
Typical Applications Circuit (Cont.)



$$V_{OUT} = [V_{REF} + (I_L \times R_{SS})] \times \frac{R1 + R2}{R1} - (I_L \times R_{SS}) \text{ (V)}$$

$$CurrentLimit = \frac{V_{SENSE}}{R_{SS}} \text{ (A)}$$

Typical Application 2



$$V_{OUT} = V_{REF} \times \frac{R1 + R2}{R1} - (I_L \times R_{SS}) \text{ (V)}$$

$$CurrentLimit = \frac{V_{SENSE} \times V_{REF}}{\left(V_{SENSE} + V_{REF}\right) \times R_{SS}} \text{ (A)}$$

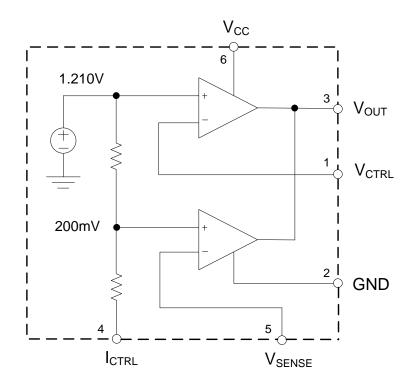
Typical Application 3



Pin Descriptions

Pin Number	Pin Name	Function
1	V_{CTRL}	Input pin of the voltage control loop
2	GND	Ground
3	V _{OUT}	Output pin. Sinking current only
4	I _{CTRL}	Input pin of the current control loop
5	V _{SENSE}	Input pin of the current control loop
6	V _{CC}	Power supply

Functional Block Diagram





Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
V _{cc}	Power Supply Voltage	20	V
V _{IN}	Input Voltage	-0.3 to V _{CC}	V
TJ	Junction Temperature	+150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
T _{LEAD}	Lead Temperature (Soldering, 5sec)	+260	°C
θ _{JC}	Package Thermal Resistance (Junction to Case)	92	°C/W

Note 4: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V _{CC}	Power Supply Voltage	2.5	18	V
T _A	Operating Temperature Range	-40	+105	°C





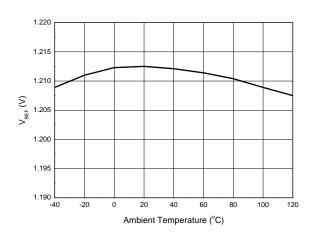
Electrical Characteristics (Vcc=5V, T_A=+25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
TOTAL CURRE	TOTAL CURRENT CONSUMPTION							
	Total Supply Current	T _A =+25°C	-	0.5	1	m ^		
I _{cc}	Not Including the Output Sinking Current	-40°C <t<sub>A< +105°C</t<sub>	_	0.6	_	mA mA		
VOLTAGE CO	NTROL LOOP					•		
Gmv	Transconduction Gain (V _{CTRL}). Sink Current Only	T _A =+25°C	1	3.5	-	- mA/mV		
GIIIV		-40°C <t<sub>A< +105°C</t<sub>	-	2.5	-			
.,	Voltage Control Loop Reference	T _A =+25°C	1.204	1.21	1.216	V		
V_{REF}		-40°C <t<sub>A< +105°C</t<sub>	1.186	_	1.234			
	1 17: 0 10/	T _A =+25°C	-	50	-	- nA		
I _{IBV}	Input Bias Current (V _{CTRL})	-40°C <t<sub>A< +105°C</t<sub>	_	100	-			
CURRENT CO	NTROL LOOP	•						
Gmi	Transconduction Gain (I _{CTRL}). Sink Current Only	T _A =+25°C	1.5	7	-	mA/mV		
.,	Current Control Loop Reference	I _{OUT} =2.5mA, T _A =+25°C	198	200	202	m)/		
V_{SENSE}		I _{OUT} =2.5mA, -40°C <t<sub>A< +105°C</t<sub>	192	_	208	- mV		
	Ourself Out of Pin Land 2000 and	T _A =+25°C	-	25	_	- μΑ		
I _{IBI}	Current Out of Pin I _{CTRL} at 200mV	-40°C <t<sub>A< +105°C</t<sub>	-	50	_			
OUTPUT STAGE								
V _{OL}	Low Output Voltage at 10mA Sinking Current	T _A =+25°C	_	200	_	mV		
	Output Short Circuit Current.	T _A =+25°C	-	27	50			
l _{os}	Output to V _{CC} , Sink Current Only	-40°C <t<sub>A< +105°C</t<sub>	-	35	-	mA		

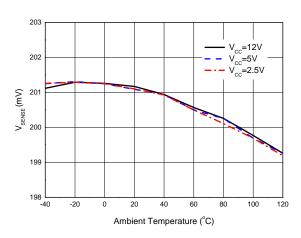


Performance Characteristics

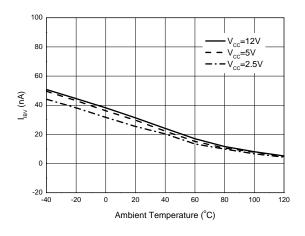
V_{REF} vs. Ambient Temperature



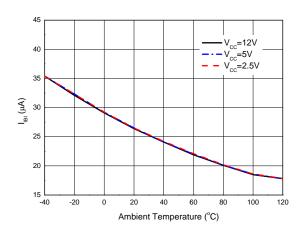
V_{SENSE} vs. Ambient Temperature



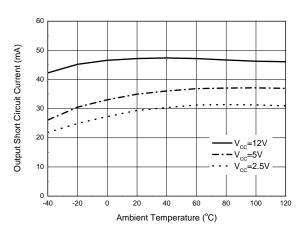
IIBV vs. Ambient Temperature



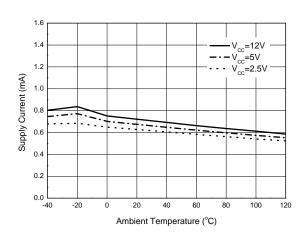
IIBI vs. Ambient Temperature



Output Short Circuit Current vs. Ambient Temperature

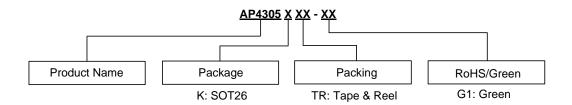


Supply Current vs. Ambient Temperature





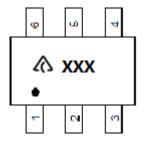
Ordering Information



Package	Temperature Range	Part Number	Marking ID	Packing
SOT26	-40 to +105°C	AP4305KTR-G1	G2B	3000/Tape & Reel

Marking Information

(Top View)



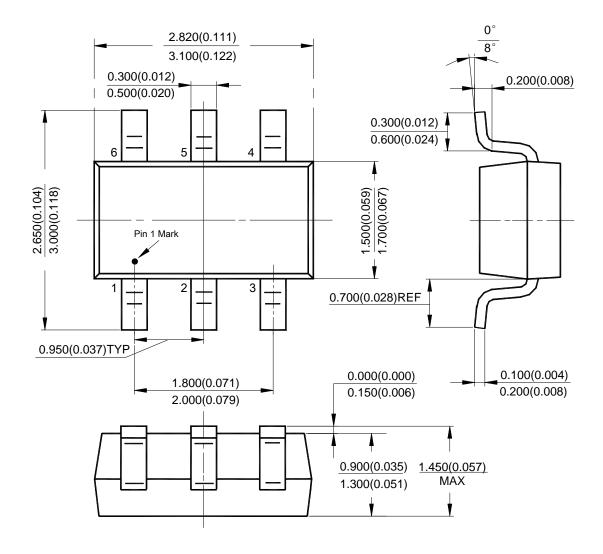
 $oldsymbol{\Lambda}_{: \mathsf{Logo}}$

XXX: Marking ID (See Ordering Information)



Package Outline Dimensions (All dimensions in mm(inch).)

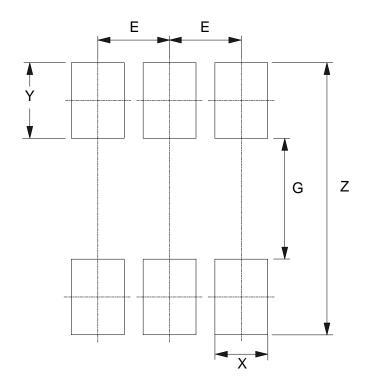
(1) Package Type: SOT26





Suggested Pad Layout

(1) Package Type: SOT26



Dimensions	Z	G	X	Y	E
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037



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